



Induction Heating of Carbon-Fiber Composites: Experimental Verification of Models

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Induction Heating of Carbon-Fiber Composites: Experimental Verification of Models

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Abstract

Heating of continuous carbon-fiber-reinforced polymers (CFRP's) by the application of an alternating magnetic field has been shown to be due to dielectric losses in the polymer. Models that predict thermal generation in these composites are input to a finite element heat-transfer analysis, providing the predicted transient thermal profile in the plane of the laminate. The validity of the global thermal generation model is established through an experimental test matrix in which various specimen configurations are evaluated and compared with theoretical predictions of transient surface temperatures.

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1. Introduction

A new theory of dielectric mechanisms for induction heating of continuous carbon-fiber composites was reported previously [1]. Based on these mechanisms, a global model was developed [2] that systematically defined the electromagnetic response of cross-ply laminated composites to alternating magnetic fields with some component of flux normal to the surface of the composite material. The global model consists of three fundamentally separate submodels that consider the in-plane electromagnetic response [3], the through-thickness response [4] and, finally, the global generation of heat and the quantification of the surface temperature profile presented in this paper. A thermal submodel is required for the comparison of predicted and measured temperatures at any point on the surface of a sufficiently thin laminated composite plate. Comparison of experimental with predicted surface temperatures can establish the validity of the postulated mechanisms of induction heating in continuous carbon-fiber composites.

Figure 1 shows an outline of the thermal submodel with the input parameters supplied by the foregoing submodels [1-5]. The planar grid submodel provides a two-dimensional (2-D) potential difference distribution for each ply-ply interface. The fiber layer submodel provides a key parameter γ describing the effective capacitive layer interaction distance and, thus, the profile of heating through the thickness for each orthogonal or off-axis ply-ply interaction in the laminate. These models can be combined to generate a three-dimensional (3-D) heat-source distribution in the laminate. In turn, this heat-source distribution can be used as input into a finite element heat-transfer model, which determines the surface thermal history of the laminate. This latter process is herein termed the "thermal submodel."

The predicted transient surface temperatures obtained from the thermal submodel are compared to experimental surface temperature measurements. ICI Fiberite's prepreg product APC-2 was used in the experimental studies. This material consists of ICI's poly-etheretherketone (PEEK) semicrystalline thermoplastic resin and continuous AS-4 graphite fibers.

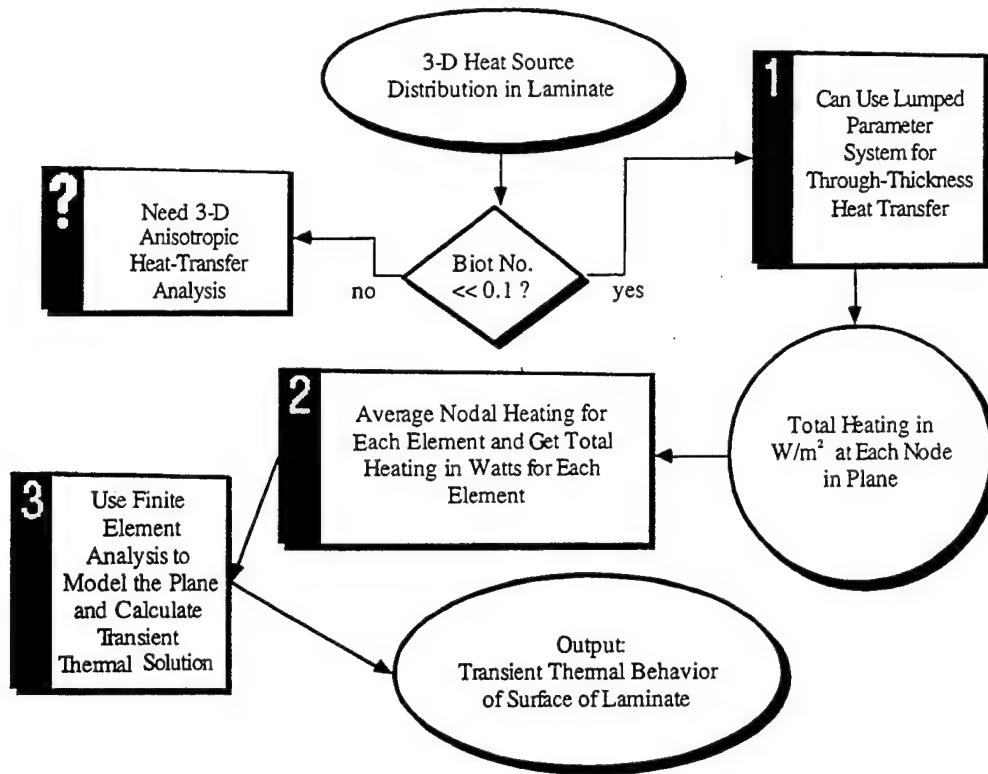


Figure 1. Outline of Thermal Submodel.

2. Thermal Conduction Considerations

The heating patterns in the plane, predicted by the planar grid submodel [2, 3], and those through the thickness, predicted by the fiber layer submodel [2, 4], combine to form a complex 3-D distribution of thermal generation in the laminate. Although the models can predict this energy generation point by point, it is difficult to translate these results into time-variant temperature distributions. Gradients in the plane can be accounted for through a discretization of the surface.

In general, a 3-D transient anisotropic ply-ply thermal analysis would be required. In our experiments, relatively thin laminates, where thermal gradients through the thickness are shown to be negligible, are studied to confirm the planar distribution of heating. To establish this fact, the through-thickness heat-transfer analysis considers the heat-generation profiles that were

formulated in earlier work [2, 3], which can be somewhat complex. Each possible ply-ply interaction has such a profile and the resulting profile for a multi-ply laminate may consist of several extremum as illustrated in Figure 2.

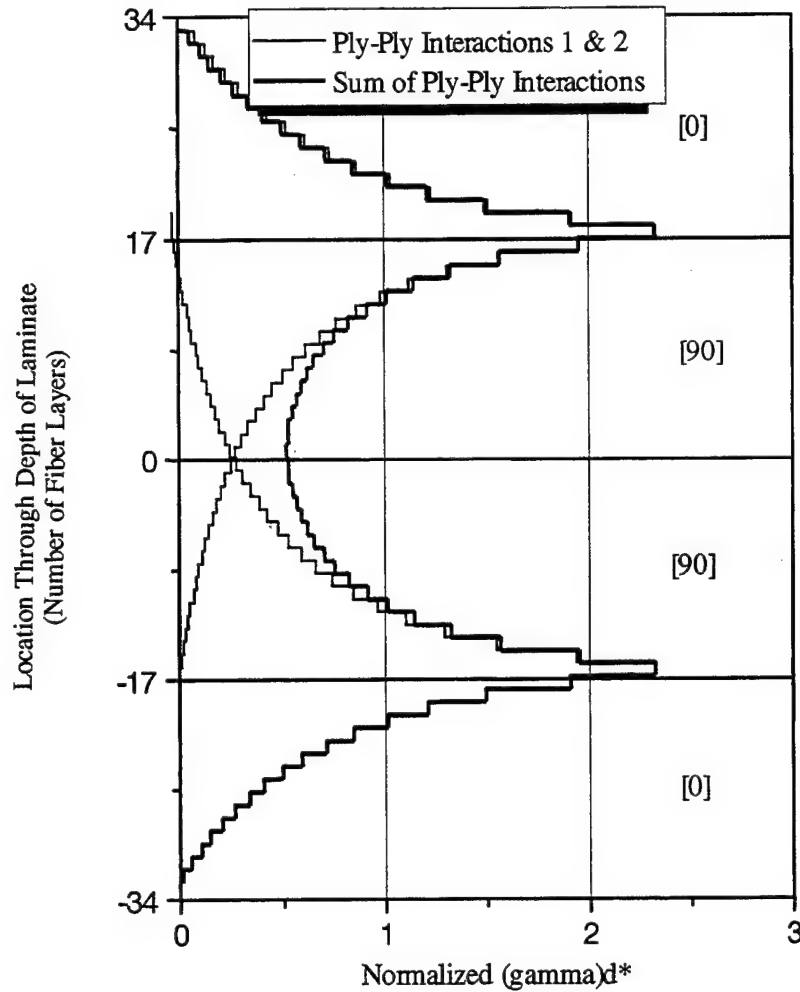


Figure 2. Superposition of Capacitive Layer Interaction Parameter, γd^* , Distributions for $[0/90_2]$ and $[90_2/0]$ Configurations. The Summation of These Distributions Provides the Gamma Distribution for the $[0/90]_s$ Configuration.

The profile within each ply can be represented by a third-order polynomial. Steady-state and transient solutions are obtained readily for a single ply-ply interaction using the equations of heating, $q(x)$, as a function of through-thickness dimension and a surface convection boundary condition. If the polynomial is of the form $a + bx + cx^2$ so that,

$$q(x) = \beta(a + bx + cx^2), \quad (1)$$

with

$$\beta = \frac{\omega \epsilon_o \kappa \tan \delta V^2}{L}, \quad (2)$$

where ω is the angular frequency, ϵ_o is the permittivity of vacuum (8.85×10^{-12} f/m), κ is the relative dielectric constant of the polymer, $\tan \delta$ is the imaginary part of the complex dielectric constant of the polymer, V is the fiber-fiber interaction potential difference, and L is the characteristic dimension through which the electric field created by V acts [1]. The transient surface temperature can be written as

$$T(x, t) = T_x + \psi(x, t) + \Phi(x). \quad (3)$$

The term $\psi(x, t)$ is the transient part of the solution, and $\Phi(x)$ is the steady-state part, viz.,

$$\Phi(x) = \frac{\beta}{k_{33}} \left[\frac{1}{2} a(L^2 - x^2) + \frac{1}{6} b(L^3 - x^3) + \frac{1}{12} c(L^4 - x^4) \right] + \frac{\beta}{h} \left[aL + \frac{1}{2} bL^2 + \frac{1}{3} cL^3 \right], \quad (4)$$

where L is the half-thickness of the two-ply laminate, k_{33} is the thermal conductivity through the thickness, h is the combined convective and radiative heat-transfer coefficient, and x is the distance from the ply-ply interface toward the surface of the laminate. The transient part of the solution is written as

$$\psi(x, t) = \sum_{n=1}^{\infty} A_n \cos\left(\frac{n\pi}{L} x\right) \exp\left(-\left(\frac{n\pi}{L}\right)^2 \alpha^2 t\right), \quad (5)$$

with

$$A_n = \frac{-\beta}{2n\pi k_{33}} \left[aL + \frac{1}{2}bL^2 + \frac{1}{3}cL^3 \right]. \quad (6)$$

The steady-state solution can be obtained independently in terms of the temperature at the surface, T_s :

$$T = T_s + \frac{h\theta}{k_{33}}(L-x) - \frac{\beta}{k_{33}} [\text{fourth order polynomial in } x], \quad (7)$$

where

T_s = equilibrium temperature at the surface, and

$$\theta = T_s - T_\infty.$$

Using the previous equations and the parameters of Table 1, the maximum temperature difference in a representative laminate can be determined from both the transient and steady-state solutions. Figure 3 displays the results for the representative laminate at various time increments. For the transient solution, the largest difference in temperature between the ply-ply interface, T_o , and the laminate surface, T_s , occurs at small time. At time $t = 1$ s., this difference is approximately 5.6% of the surface temperature, T_s . At $t = \infty$, the transient solution is equivalent to the steady-state solution and the inside-to-outside difference is only 0.15% of the wall temperature.

Due to the time increments used in the experimental testing, 5–10 s, and the accuracy limitations of the equipment, temperature differences through the thickness are not measurable. Several tests were performed with thermocouples embedded at various points through the thickness of a [0₃/125-μm film/90₃] laminate. No differences in temperature through the thickness were observed. In contrast, large variations in the plane are predicted enabling the verification of the planar grid model and the average heating through the thickness, $\int q(x)$.

Table 1. Input Parameters for the Representative Laminate Case Study. Some Values Are “Rational Estimates” for Determining the Maximum Possible Temperature Difference Within a Six-Ply Laminate, With an Interply Resin Thickness of $h_o = 127 \mu\text{m}$

Parameter	Symbol	Value	Dimension
Curve Fit Parameter	a	0.5169	1/m
Curve Fit Parameter	b	-1821.4	1/m ²
Curve Fit Parameter	c	1.484e6	1/m ³
See Equation (2)	β	23.32	W/m ²
Angular Frequency	ω	2π (70,000)	1/s
Emissivity Constant	ϵ_o	8.85e-12	f/m
Dielectric Constant	κ	3.6	dim.less
Loss Tangent	$\tan\delta$	0.16	dim.less
Maximum Voltage	V_{max}	68.0	V
Convection Coefficient	h	9.1	W/m ² °C
Thermal Conductivity	k_{33}	0.3	W/m°C
Ply Half-Thickness	L	4.445e-4	m
Coil Current	I	30	amp
Ambient Temperature	T_∞	25	°C

These results are also predicted by the Biot number, hL/k , and the rule-of-thumb that if $Bi < 0.1$, then a lumped-parameter analysis can be used since no significant temperature gradients exist through the material of characteristic dimension L . In this example for a six-ply laminate, the Biot number is approximately 0.012. Correspondingly, an APC-2 composite laminate would need to be greater than about 16 plies thick (i.e., approximately 0.2 cm or 0.08 in) before a more complex 3-D analysis would be required and appreciable differences in through-thickness temperature could be experimentally measured. The following section discusses how the output from the previous submodels is consolidated and used in a finite element program to model transient surface temperatures.

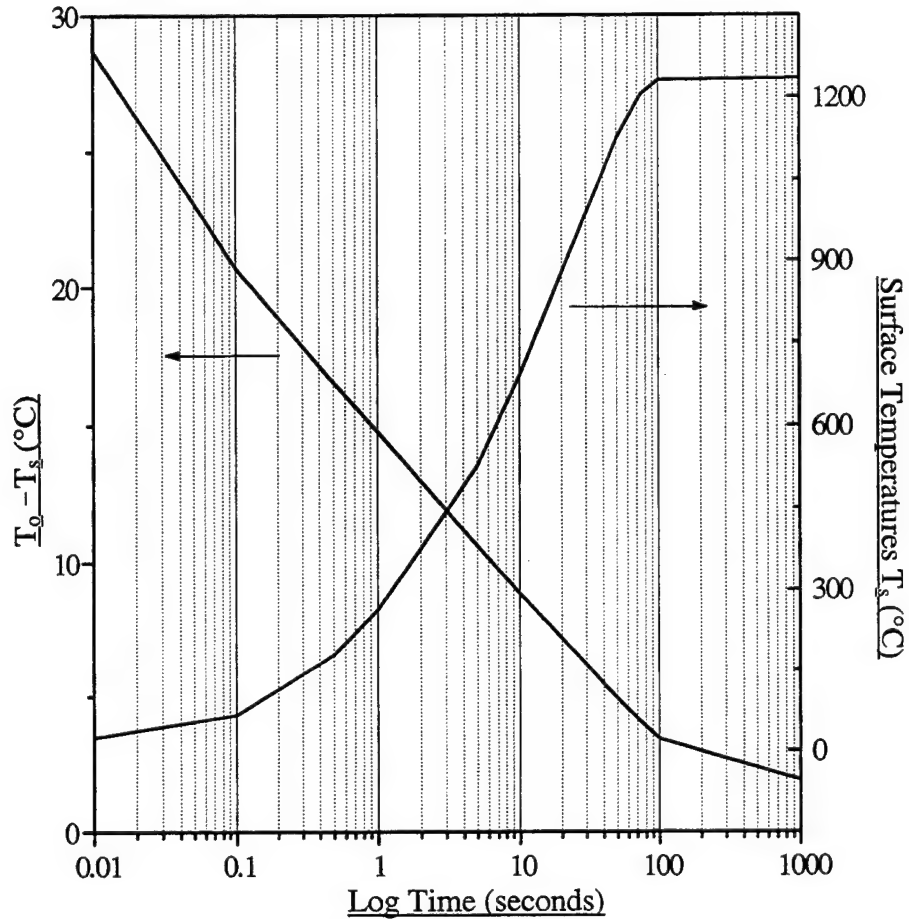


Figure 3. Results of Closed-Form 1-D Heat Transfer Solution for an Example Six-Ply Laminate. T_o is the Interface Temperature, and T_s is the Surface Temperature. Note That the Difference in Transient Temperature Between the Surface of the Specimen and the Center Is Negligible.

3. Elemental Heat Generation and Finite Element Heat-Transfer Solution

The desired input for the thermal model is the heat generation, q_{ij} , in the planar grid element (i,j) and its combined convective and radiative losses, h_{ij} . The nondimensional output of the planar grid submodel's program for node " r,s " is Λ_{rs} , where

$$\Lambda_{rs} = \frac{v_{rs}}{\omega \phi_B}. \quad (8)$$

The quantity v_{rs} is the nodal voltage in volts at node (r,s) , ω is the angular frequency, and ϕ_B is the magnetic flux in webers. The volume-normalized nondimensional output of the fiber layer submodel's program is Γ :

$$\Gamma = \frac{\gamma_{total} d^*}{b + n + m}, \quad (9)$$

where γ_{total} is the effective parameter of heating through the thickness of the laminate defined by the capacitive layer interaction calculations, d^* is the effective fiber layer separation distance, b is the ratio of the ply-ply separation distance h_o to the effective fiber layer separation distance d^* (i.e., $b = h_o/d^*$), and m and n are the number of fiber layers above and below the ply-ply interface respectively. The nondimensional parameters Λ_{rs} and Γ are used to obtain the total heating per element in the thermal model's grid. The grid used in the thermal model is equivalent to that used in the planar grid model. The nodal voltage in equation (8), v_{rs} , can be solved for in terms of the program output, Λ_{rs} . Since the thermal model requires elemental heating values, the nodal voltages are averaged over the element they represent:

$$V_{ij} = \frac{1}{4}(v_{r,s} + v_{r,s+1} + v_{r+1,s} + v_{r+1,s+1}), \quad (10)$$

where V_{ij} is the elemental voltage for the element (i,j) of the models' grid (the commas are used only to separate the subscripts). The elemental heat generation in watts/cubic meter can now be written as,

$$q_{ij} = \omega \epsilon_o \kappa \tan \delta \Gamma V_{ij}^2, \quad (11)$$

where the imaginary part of the complex dielectric constant, $\tan\delta$, is a function of temperature [2]. From these procedures, the quantity X_{ij} can be obtained:

$$X_{ij} = \frac{q_{ij}}{\tan\delta}, \quad (12)$$

with X_{ij} in watts/cubic meter.

The finite element analysis (FEA) program FEHT was used for the heat-transfer analysis. A 7×7 element grid was used as illustrated in Figure 4. A grid size of 7×7 is accurate for centered-coil tests in which the coil's flux area covers at least 14% of the surface of the specimen as determined by a convergence study for the planar grid model [2], with an error of about 7% from the infinitely fine grid. This grid size was the maximum size that could be used for the experimental arrangement described in the following section. It represents a practical choice in terms of computer time limitations, geometric feasibility, and sufficient surface temperature measurement accuracy for comparison to the predicted transient surface temperature profile. Each of the 49 planar grid model elements from $(i,j) = (1,1)$ to $(7,7)$ were broken up into eight FEA elements, for a total of 392 FEA elements, and 225 FEA nodes.

Figure 5 shows how each square model element was partitioned into its FEA elements. The quantity X_{ij} from equation (12) represents the thermal generation in the model element (i,j) . X_{ij} has a gradient over the model element area. This gradient can be calculated from the original v_{rs} quantities output from the ply-ply interaction model as defined in equation (8). The gradients between the four nodal v_{rs} quantities for each model element are assumed to be linear so that the heating for each FEA element can be calculated through a simple linear regression involving the nodal voltage parameters v_{rs} and X_{ij} . Figure 5 defines the nodal locations "a" through "d" in addition to the v_{rs} nodes.

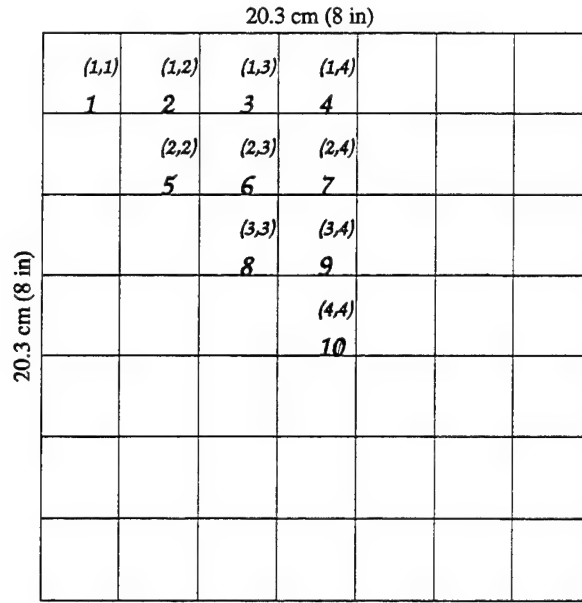


Figure 4. Grid Used in Final Experimental Test Matrix. The Planar Grid Element Labeled 1–10 Represent the Entire Surface Due to Symmetry in the Cross-Ply Specimen and in the Central Placement of the Coil.

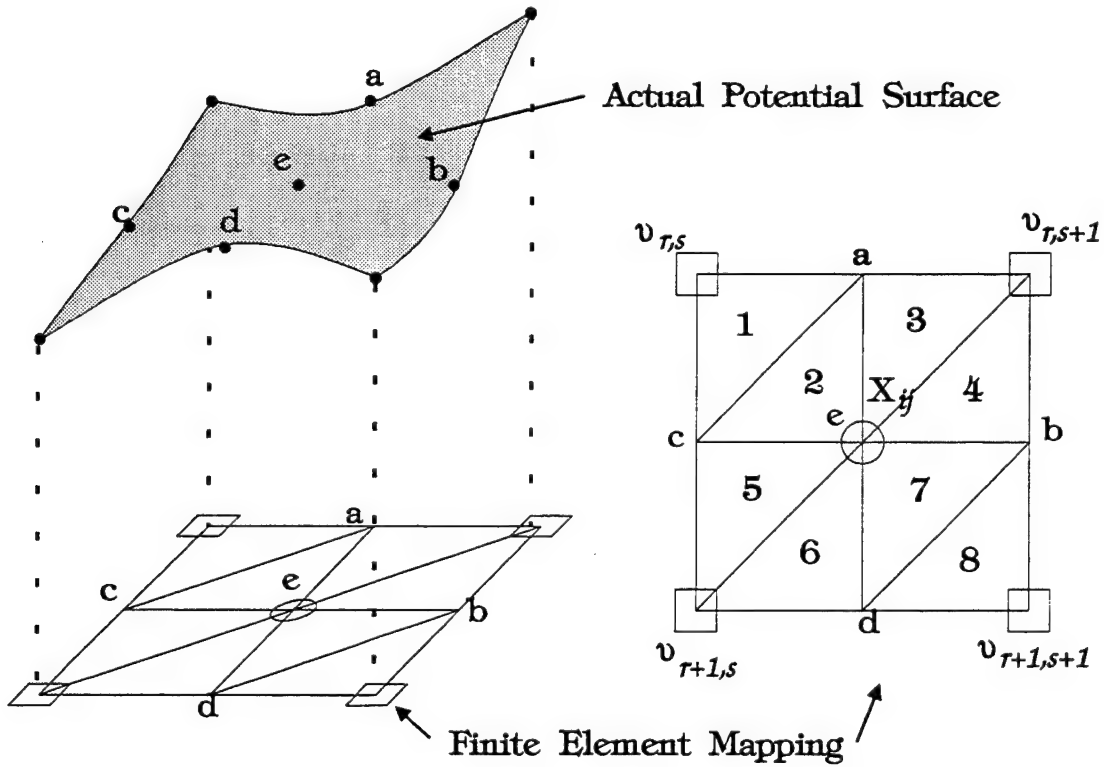


Figure 5. Mapping From Voltage Surface to Finite Element Model Nodes.

Assuming linear gradients along the edges, the nodal heating values at all nodes can be calculated as

$$\begin{aligned}
 a_{ij} &= \frac{X_{ij}}{V_{ij}} \left[v_{r,s} + \frac{v_{r,s+1} - v_{r,s}}{2} \right], \\
 b_{ij} &= \frac{X_{ij}}{V_{ij}} \left[v_{r,s+1} + \frac{v_{r+1,s+1} - v_{r,s+1}}{2} \right], \\
 c_{ij} &= \frac{X_{ij}}{V_{ij}} \left[v_{r,s} + \frac{v_{r+1,s} - v_{r,s}}{2} \right], \text{ and} \\
 d_{ij} &= \frac{X_{ij}}{V_{ij}} \left[v_{r+1,s} + \frac{v_{r+1,s+1} - v_{r+1,s}}{2} \right].
 \end{aligned} \tag{13}$$

The eight FEA element heating values per grid element (i,j) are given by

$$\begin{aligned}
 X_{ij,1} &= \frac{1}{3} \left[\frac{X_{ij}}{V_{ij}} v_{r,s} + a_{ij} + c_{ij} \right], \\
 X_{ij,2} &= \frac{1}{3} [X_{ij} + a_{ij} + c_{ij}], \\
 X_{ij,3} &= \frac{1}{3} \left[\frac{X_{ij}}{V_{ij}} v_{r,s+1} + X_{ij} + a_{ij} \right], \\
 X_{ij,4} &= \frac{1}{3} \left[\frac{X_{ij}}{V_{ij}} v_{r,s} + X_{ij} + b_{ij} \right], \\
 X_{ij,5} &= \frac{1}{3} \left[\frac{X_{ij}}{V_{ij}} v_{r+1,s} + X_{ij} + c_{ij} \right],
 \end{aligned}$$

$$\begin{aligned}
X_{ij,6} &= \frac{1}{3} \left[\frac{X_{ij}}{V_{ij}} v_{r+1,s} + X_{ij} + d_{ij} \right], \\
X_{ij,7} &= \frac{1}{3} [X_{ij} + b_{ij} + d_{ij}], \text{ and} \\
X_{ij,8} &= \frac{1}{3} \left[\frac{X_{ij}}{V_{ij}} v_{r+1,s+1} + b_{ij} + d_{ij} \right].
\end{aligned} \tag{14}$$

The average of $X_{ij,1}$ through $X_{ij,8}$ is not exactly equal to X_{ij} due to the assumption of linear gradients between adjacent nodes; however, this error was consistently less than the 7% error inherent in the planar grid analysis for the specimens modeled and tested. For the centered-coil tests used, some model elements, (i,j) , had equivalent heat-generation input values. Due to this symmetry, 10 distinct input values were possible, as shown in Figure 4. The "heat generation" term needed for the thermal calculation is

$$q_{ij,k} = \tan\delta(T) - \frac{2h_{ij,k}(T)}{L}, \tag{15}$$

where

$q_{ij,k}$ = total heat flux in FEA element k of model element (i,j) ,

$X_{ij,k}$ = output after linear regression fits,

$\tan\delta(T)$ = dielectric loss tangent as a function of element temperature,

$h_{ij,k}$ = combined convective and radiative heat transfer losses from each surface of the plate as a function of element temperature, and

$L = (b + m + n)d^* = \text{thickness of plate.}$

The two fundamental parameters, $\tan\delta(T)$ and $h_{ij,k}(T)$, were experimentally investigated. A study of the loss tangent properties of PEEK was performed and is presented, in detail, in Fink [2] and Fink, McCullough, and Gillespie [5]. The convection heat transfer coefficient, h , was experimentally determined for the test configuration. This analysis is discussed in Fink [2].

Other input to the program includes the density, heat capacity and thermal conductivity of the material. The FEA program requires the input of effective quasi-isotropic thermal properties. The thermal conductivity of an APC-2 prepreg ply is highly anisotropic; the value in the fiber direction, k_{11} , is approximately 6.20 W/m°C, and, in the transverse direction, k_{22} , is approximately 0.34 W/m°C from fiber volume fraction calculations using polymeric and anisotropic fiber properties (Table 2) and a fiber volume fraction of 0.61. For orthotropic cross-ply laminates in which the number of 0° plies is equal to the number of 90° plies ($M = N$), isotropic values for thermal conductivity can be used.

Table 2. Material Properties for Poly-Etheretherketone and AS-4 Carbon Fibers

	Specific Heat J/kg°C	Density kg/m ³	Thermal Conductivity W/m°C
Matrix (PEEK) [6]	1,340	1,320	0.2512
Fiber (AS-4 Graphite) [8]	921	1,800	0.426 (trans.) 10.0 (long.)

Consider a $[0_M/h_o_thick_film/90_N]$ cross-ply laminate consisting of M 0° plies, an interlayer resin thickness of h_o , and N 90° plies. A "longitudinal" value for the thermal conductivity, k_L , of the laminate can be estimated through volume averaging:

$$k_L^{laminate} = \frac{Mk_{11}^{ply} + Nk_{22}^{ply} + \frac{h_o}{127}k_m}{M + N + \frac{h_o}{127}}, \quad (16)$$

where

k_m = thermal conductivity of matrix ≈ 0.2512 W/m°C, and

h_o is measured in microns.

For $M = N = 1$ and $h_o = 8$ μm (a normally consolidated [0/90] cross-ply laminate), k_L for the laminate is approximately 3.18 W/m°C. For balanced laminates, $M = N$, the longitudinal and transverse conductivities are equivalent, $k_L = k_T$. As long as thermal gradients through the thickness are minimal, the in-plane thermal conductivity is isotropic. Similar calculations are possible for determining the density, ρ , and specific heat, c_p , values for the various configurations under consideration.

4. Experimental Procedures

The thermal submodel described previously completes the global model of heating in cross-ply, continuous carbon-fiber-reinforced composites. The local, in-plane, and through-thickness submodels are combined to provide input to a finite element heat-transfer analysis, providing the predicted transient thermal profile in the plane of thin laminates. Error calculations concerning through-thickness thermal gradients and linearity of potential field gradients in the plane were considered in the solution. As shown later, the validity of the assumptions that encompass the thermal submodel are supported by the close agreement with the model's output with experimental data.

The following sections provide experimental evidence supporting the global model. The various submodels previously discussed [1–5] established the significant physical parameters required to characterize the response of cross-ply composites to alternating magnetic fields. Various material and experiment-related quantities are evaluated individually and tabulated with their corresponding errors. An experimental test matrix was performed that represents a practical range of the significant parameters and the effects of changing those parameters individually.

Table 3 shows the 20.3-cm-square (8 in) plate lay-up configurations fabricated and tested using coil currents of 6, 10, and 20 amp; the matrix consists of 75 separate tests. The placement of the 10 surface thermocouples is shown in Figure 4. Specimens were labeled as indicated in Table 3 and are referred to by the codes shown in parentheses, e.g., (0_11) represents the 0-mil interlayer $[0_1/90_1]$ specimen and (5_22) represents the 5 mil interlayer $[0_2/90_2]$ laminate specimen where 1 mil = 25.4 μm . Specimens are further referred to as, for example, (0_11_6), where the "6" represents the coil current used in amps.

Table 3. Laminate Configurations Processed for Final Test Matrix. Each 20.3-cm-Square (8 in) Specimen Was Tested With a 10.2-cm-Diameter (4 in) Centered Helmholtz-Type Coil at 6-, 10-, and 20-amp Applied Coil Current.

		Nominal Interlayer PEEK Resin Film Added, h_o (1 mil = 25.4 μm)				
		(None)	1 mil	2 mil	3 mil	5 mil
	(1,1)	A (0_11)	B (1_11)	C (2_11)	D (3_11)	E (5_11)
	(2,2)	F (0_22)	G (1_22)	H (2_22)	I (3_22)	J (5_22)
(M,N)	(3,3)	K (0_33)	L (1_33)	M (2_33)	N (3_33)	O (5_33)
	(1,2)	P (0_12)	Q (1_12)	R (2_12)	S (3_12)	T (5_12)
	(1,3)	U (0_13)	V (1_13)	W (2_13)	X (3_13)	Y (5_13)

DuPont Co. provided the use of an Ameritherm 50–200-kHz 15-kW induction generator. The machine self-tunes the frequency for the coil and load placed on it. Output includes the frequency, current to coil, and voltage applied. The current to the coil reading has about a 2-amp error in the reading itself, which can be 100% of the total reading when applying low power to the coil. The induction coils were fabricated using 1/4-in-outside-diameter. Copper tubing and compression fittings using a Helmholtz design, which provides a very uniform field with all field lines normal to the plane of the specimen and with constant flux across the plane of the specimen. The coil design used in our experiments tunes to the Ameritherm equipment at 70 kHz. The 20.3-cm-square (8 in) specimens were placed in a wooden frame, which serves two

purposes. First, it grips the specimen along all four edges (with 1/8-in overlap at the edges) and keeps the unbalanced (1,2) and (1,3) and the unsymmetrical laminates (all specimens) square in the plane. Second, the frame assembly slides vertically between two grooved wooden guides attached to a wooden base, allowing the frame and, thus, the specimen to be rapidly dropped into the stationary Helmholtz coil position. This provides an instant-on capability for the field not otherwise possible with the Ameritherm induction equipment at such low coil-currents, due to the self-tuning nature of the equipment. The thermocouples were placed on the specimen and each read by a digital E-type thermocouple reader (a computerized input was not available). The accuracy of these readers is ± 1 °C. The process, including the thermocouple readers and a digital timer, was recorded on videotape, which was later reviewed to record the thermocouple readings at 10-s increments. These time increments provided sufficient accuracy for comparison to predictions.

5. Model Predictions

Table 4 indicates the values used in the models for comparison with the final experimental matrix. The application of the predictive models is illustrated for the laminate configuration (0_11_6). Nondimensional laminate and induction source parameters (generally, those without error values) were input into the planar grid in-plane interaction submodel, providing a dimensionless nodal voltage matrix. Separately, dimensional laminate characteristics and their respective errors were input to the fiber layer through-thickness interaction submodel, providing the total effective inverse fiber-layer interaction distance per unit thickness. These outputs were combined with additional material and laminate properties for input into a program based upon the local and in-plane interaction submodels. This output provides the 7×7 heat-generation matrix per unit loss tangent with upper and lower error bounds. These results were then used as input to the 2-D FEA heat-transfer submodel along with loss tangent and surface heat-loss functions with temperature to provide the predicted transient thermal behavior at the surface of the laminates.

Table 4. Values and Associated Errors for Material and Experimental Parameters

Property	Symbol	Source	Value	Error	Units
Coil Current	I	Machine Reading	6, 10, 20	± 2	Amps
Magnetic Flux	ϕ_B	Coil Calc's [2]	$1.219e-6 \cdot I$	Lo: $1.08e-6 \cdot I$ Hi: $1.219e-6 \cdot I$	Webers
Frequency	f	Machine Reading	70,000	± 2000	Hertz
Dielectric Constant	ϵ	Measured [5]	3.72	± 0.10	dim.less
Dielectric Loss Tangent	$\tan \delta$	Measured [5]	Varies With T [2]	3 % [2]	dim.less
Fiber Diameter	d_f	[8]	8	± 0.5	microns
Fiber Volume Fraction	X_f	[9]	0.61	± 0.01	dim.less
Radiation Heat-Transfer Losses	R	Estimated [2]	Varies With T [2]	N/A	$W/m^2 \cdot ^\circ C$
Number of Fiber Layers Per Ply	m/M,n/N	Measured [2]	17.3	± 1.6	dim.less
Actual Interply Thickness Per Unit Nominal Input	ho/Nom. Input	Measured [2]	0.840 Except for 0-mil Specimen	0.065 Except for 0-mil Specimen	dim.less
Total Laminate Thickness	2L	Calculated	Varies With Specimen	Varies With Specimen	meters
Wall Temperature	T_s	Measured	Varies (Depends on Rate)	± 1	$^\circ C$
Convective Heat-Transfer Coefficient	h	Measured [2]	9.1	± 0.1	$W/m^2 \cdot ^\circ C$
Heat Capacity	c_p	Calculated	[2]	N/A	$J/k^\circ C$
Density	ρ	Calculated	[2]	N/A	kg/m^3
Thermal Conductivity	k	Calculated	[2]	N/A	$W/m^\circ C$

Equation (17) is the input unit magnetic flux matrix for the planar grid model (the total input sums to unity). This input best represents the shape and placement of the coil and the distribution of flux on the surface for a 7×7 grid. Note that, although the distribution of flux is continuous in the actual laminate plane, the coarse modeled grid of the planar grid model necessarily has some partially filled elements as has been previously established [2].

$$\frac{[\phi_B]}{\sum_{j=1}^7 \sum_{i=1}^7 \phi_{Bij}} = \begin{bmatrix} 0 & 0 & 0 & 0 & 0 & 0 & 0 \\ 0 & 0 & 0 & 0 & 0 & 0 & 0 \\ 0 & 0 & 0.071 & 0.143 & 0.071 & 0 & 0 \\ 0 & 0 & 0.143 & 0.143 & 0.143 & 0 & 0 \\ 0 & 0 & 0.071 & 0.143 & 0.071 & 0 & 0 \\ 0 & 0 & 0 & 0 & 0 & 0 & 0 \\ 0 & 0 & 0 & 0 & 0 & 0 & 0 \end{bmatrix}. \quad (17)$$

Equation (18) displays an example of the 8×8 matrix of dimensionless nodal voltage (i.e., voltage per unit frequency per unit flux) for the (0_11_6) laminate analysis. The nondimensionalized total effective inverse interaction distances, γ , for the predicted parameters and their errors (Table 4) for each specimen type (and 10-mil [254 μm] interlayer thickness) were determined previously [2].

$$\Lambda_{rs} = \begin{bmatrix} 0.757 & 0.840 & 0.943 & 0.426 & 0.426 & 0.943 & 0.840 & 0.757 \\ 0.840 & 0.943 & 1.08 & 0.490 & 0.490 & 1.08 & 0.943 & 0.840 \\ 0.943 & 1.08 & 1.27 & 0.581 & 0.581 & 1.27 & 1.08 & 0.943 \\ 0.426 & 0.490 & 0.081 & 0.175 & 0.175 & 0.081 & 0.490 & 0.426 \\ 0.426 & 0.490 & 0.081 & 0.175 & 0.175 & 0.081 & 0.490 & 0.426 \\ 0.943 & 1.08 & 1.27 & 0.581 & 0.581 & 1.27 & 1.08 & 0.943 \\ 0.840 & 0.943 & 1.08 & 0.490 & 0.490 & 1.08 & 0.943 & 0.840 \\ 0.757 & 0.840 & 0.943 & 0.426 & 0.426 & 0.943 & 0.840 & 0.757 \end{bmatrix}. \quad (18)$$

Note in equation (18) that the dotted lines delineate symmetry about the one-eighth section. In the equations that follow, this symmetry is noted.

Several observations derived from parametric studies are useful in predicting the trends of through-thickness heating as a function of the number of plies (M, N) on either side of the interface and of the thickness of the matrix-rich interface, h_o . Figure 6 shows the effect of increasing M for various nominal values of h_o (data is shown without error bars for ease of reading). Note that the effect (i.e., the change in heating with increasing M) is greater for larger interface thicknesses due to the dominance of the parameter h_o . Figure 7 shows the effect of increasing h_o for the various laminate configurations. Note that the (1,2) and (1,3) configurations do not differ significantly in heating and that the (1,3) and (2,2)—each with equivalent numbers of plies—heat significantly differently; both of these observations are due to the ineffectiveness of increasing the number of plies on one side of the interface. Finally, it is of interest to compare the predicted overall “heating” of the fiber layer interaction model with a situation in which dielectric heating is restricted to the interface region, h_o . Figure 8 compares the nondimensionalized “effective” inverse interaction distances from the present model with the nondimensionalized inverse h_o (note the inverse x-axis scale to represent increasing interface thickness). As the interface thickness gets larger (i.e., inverse h_o approaches zero), the difference between the two models approaches zero since h_o dominates the heating at low values. However, at practical interface thicknesses (even for specimens with no additional PEEK interlayer film), the present model predicts heating that is 2–3 orders of magnitude higher than the situation in which heating occurs only at the interface.

The planar voltage profile of equation (18) and the total effective through-thickness interaction parameter, γ , were used to predict the heating profile in the plane of the specimen in watts/cubic meter per unit loss tangent as shown in equations (19a–c). “B” represents the predicted values, while “U” and “L” represent the upper and lower bounds calculated from the values and errors tabulated in Table 4.

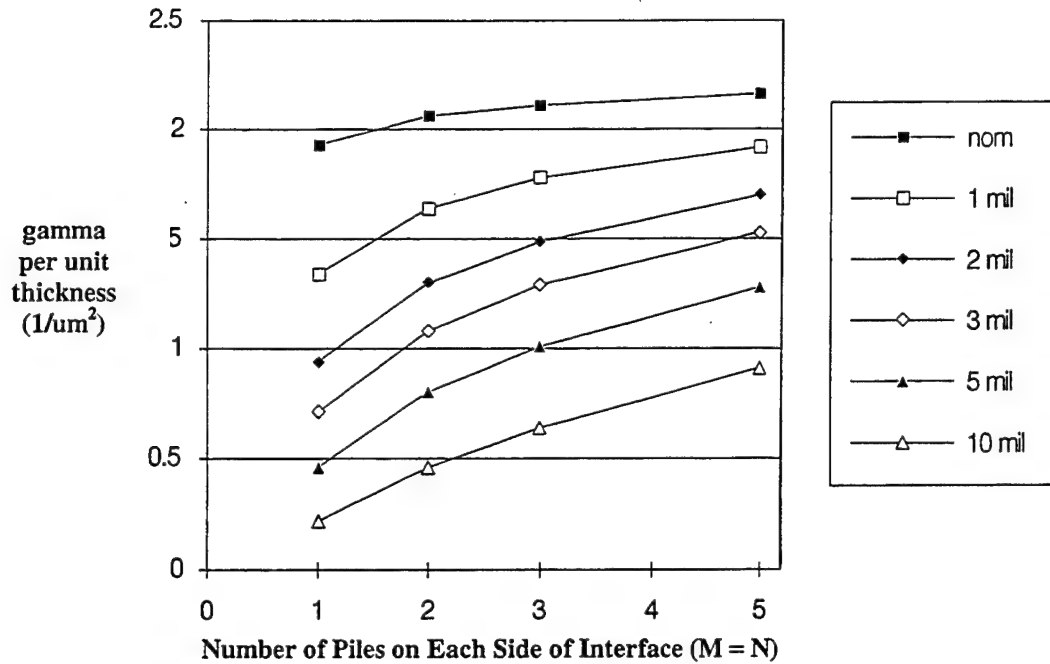


Figure 6. Predictions of Capacitive Layer Model Study of Test Matrix Specimens Showing the Effect of Increasing Ply Thickness on Heating.

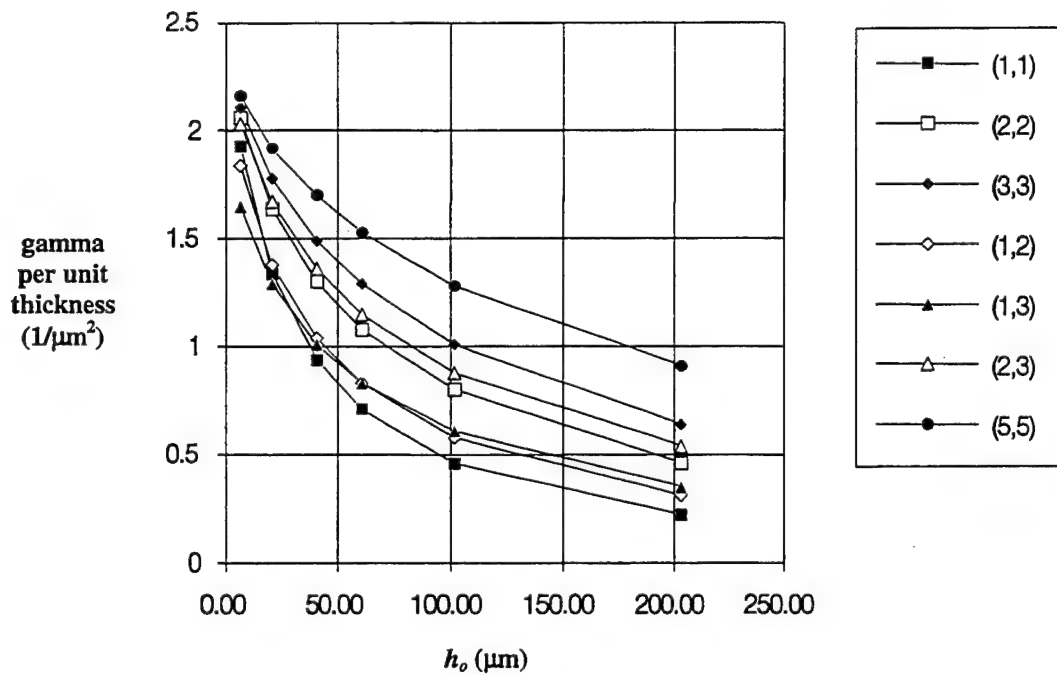


Figure 7. Predictions of Capacitive Layer Model Study of Test Matrix Specimens Showing the Effect of Increasing Interface Thickness on Heating.

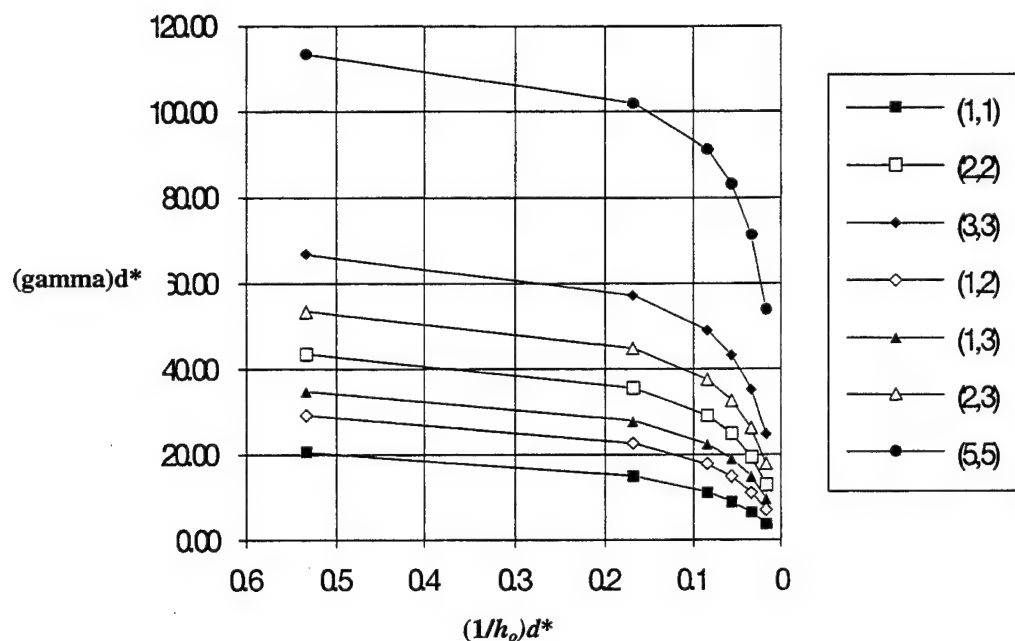


Figure 8. Predictions of Capacitive Layer Model Study of Test Matrix Specimens Comparing Nondimensional "Effective" Inverse Interaction Distances With the Nondimensionalized h_o . Note the Inverse x-Axis Scale to Represent Increasing Interface Thickness.

$$Q_B = \begin{bmatrix} 14.7 & 18.6 & 11.1 & 4.31 \\ & 24.5 & 15.0 & 5.90 \\ & & 8.71 & 2.94 \\ \text{sym.} & & & 0.627 \\ & & & & \text{sym.} \end{bmatrix} \times 10^6 \frac{W}{m^3}, \quad (19a)$$

$$Q_U = \begin{bmatrix} 23.0 & 29.2 & 17.4 & 6.76 \\ & 38.4 & 23.5 & 9.25 \\ & & 13.6 & 4.60 \\ \text{sym.} & & & 0.982 \\ & & & & \text{sym.} \end{bmatrix} \times 10^6 \frac{W}{m^3}, \text{ and } (19b)$$

$$Q_L = \begin{bmatrix} 7.06 & 8.94 & 5.33 & 2.07 \\ & 11.8 & 7.21 & 2.84 \\ & & 4.18 & 1.41 \\ \text{sym.} & & & 0.030 \\ & & & & \text{sym.} \end{bmatrix} \times 10^6 \frac{\text{W}}{\text{m}^3}. \quad (19c)$$

Note that the symmetrical placement of the coil on the specimen and the circular shape of the coil leads to only 10 unique values in the matrix Q . The 325% increase in heating from the lower bound to the upper bound appears substantial. However, this difference translates into only a 15 °C difference in surface temperature at the hottest point on the surface, as shown in Figure 9.

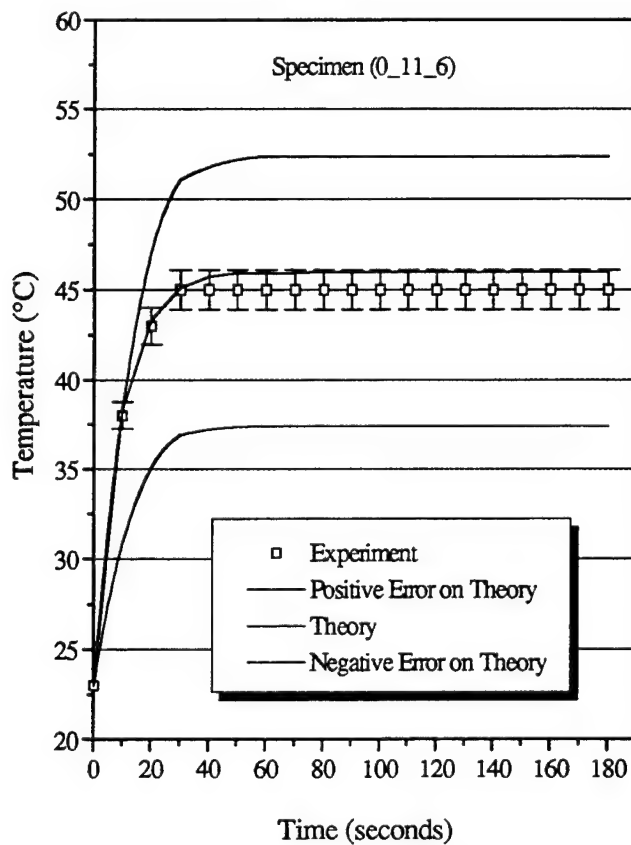


Figure 9. Experimental Surface Temperature History for Thermocouple No. 5 on (0_11_6) Test Specimen.

Equations (20a-c) show the predicted surface temperature profile and the corresponding upper and lower bounds respectively.

$$T_B = \begin{bmatrix} 33.9 & 38.4 & 31.4 & 25.3 \\ & 46.0 & 35.0 & 26.0 \\ & & 29.1 & 23.8 \\ \text{sym.} & & & 23.0 \\ & & & & \text{sym.} \end{bmatrix} \text{ } ^\circ\text{C}, \quad (20a)$$

$$T_U = \begin{bmatrix} 36.0 & 41.8 & 32.8 & 25.8 \\ & 52.4 & 37.7 & 26.2 \\ & & 30.5 & 24.0 \\ \text{sym.} & & & 23.0 \\ & & & & \text{sym.} \end{bmatrix} \text{ } ^\circ\text{C}, \text{ and} \quad (20b)$$

$$T_L = \begin{bmatrix} 29.9 & 32.9 & 28.5 & 24.6 \\ & 37.4 & 30.8 & 25.3 \\ & & 27.2 & 23.7 \\ \text{sym.} & & & 23.0 \\ & & & & \text{sym.} \end{bmatrix} \text{ } ^\circ\text{C}. \quad (20c)$$

Large differences between the theoretical bounds in surface temperature were common; especially for the lower currents. In addition to the large machine-induced error in current readings, other factors add to the disparity in the bounds of the thermal response. The sensitivity

of the microstructural properties of fiber diameter and fiber volume fraction and the macrostructural properties of interply resin-rich region thickness and average number of fibers through the thickness of a single ply have significant effects on the predicted bounds. However, experimental results are later shown to verify the predicted solution despite the wide bounds. This is due to the averaging of these properties over millions of actual nodal locations (fiber-fiber intersections), which tends to smooth out the effects of any deviations from the average in these structural properties.

6. Comparison of Predicted and Observed Temperature Profiles

Although experimental results for the nonorthotropic laminates [e.g., (1,2) and (1,3)] were obtained [2], comparable theoretical results were not feasible due to the FEA program's inability to handle anisotropic thermal conductivity properties. Accordingly, attention is directed to the orthotropic laminates (1,1), (2,2), and (3,3). The model results are obtained from the FEA nodal transient temperatures for the 10 nodes corresponding to the thermocouple locations, as shown previously in Figure 4. Only the results for the 10-amp applied coil-current tests are considered here. This current resulted in significant heating for all specimens, while remaining under the melting temperature of PEEK and, more importantly, within the range of temperatures for which the loss tangent was measured. The (0_11_6) specimen is examined in detail. Fink [2] presents extensive additional data for other specimens.

6.1 Planar Temperature. Figure 10 shows the experimental transient surface temperature results over the first 3 min. As noted previously, Figure 9 shows the predicted results for the point of highest heating on the surface of the specimen with the experimental results for the point of highest heating superimposed with the appropriate error bars. The equilibrium experimental value is 45 °C, while the theoretical equilibrium value is 46 °C, representing a $(1/(46-23)) \times 100 = 4\%$ decrease in temperature gain. Figure 11 compares the equilibrium results for all thermocouples with the corresponding predicted values. Note that the No. 2 and No. 6 thermocouple positions heated more than the theory predicted, while the No. 1 and No. 3

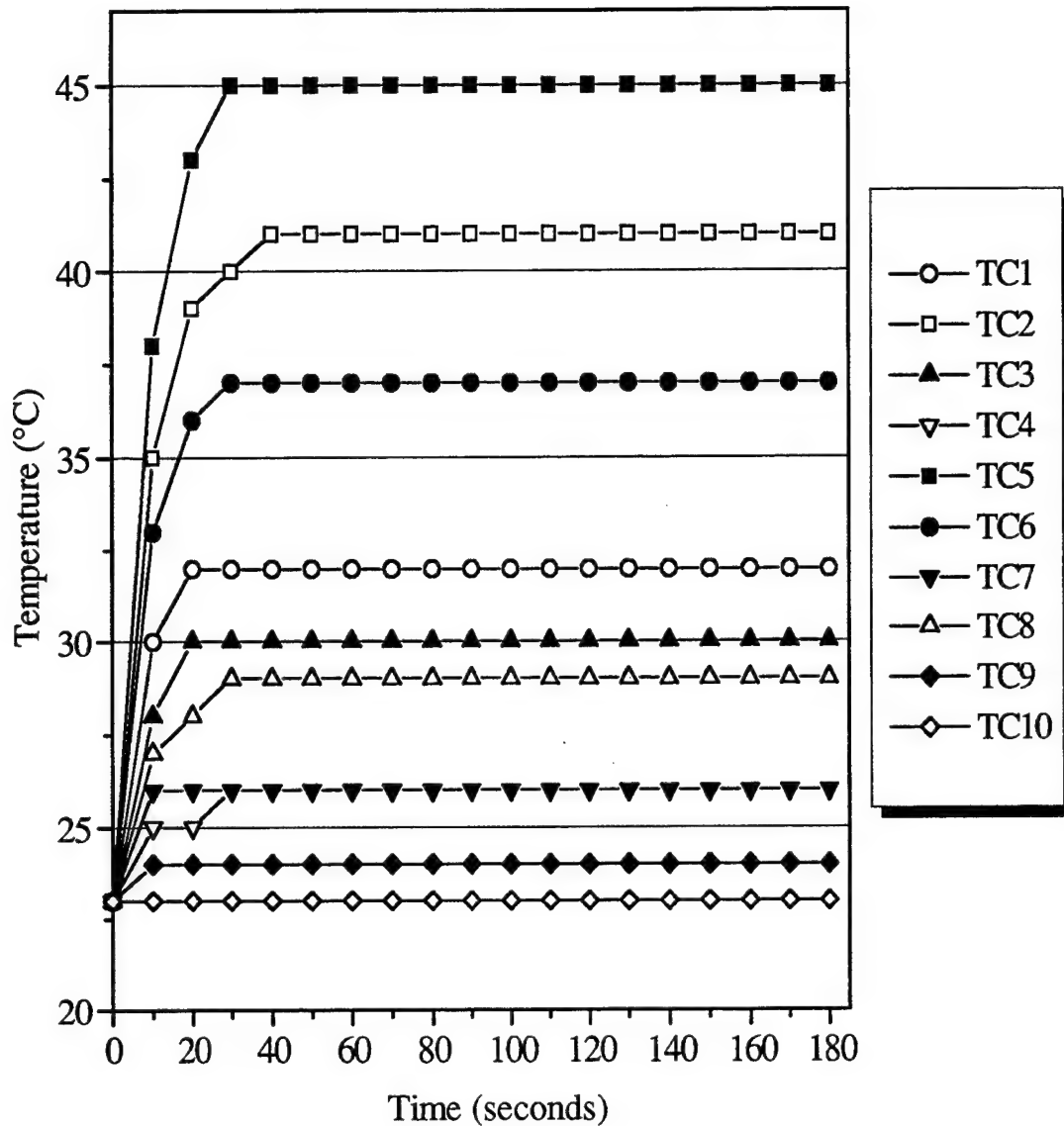


Figure 10. Experimental Transient Surface Temperature Results for Specimen (0_11_6) for All Nodal Positions.

positions heated less than the model predicted. Figure 12 indicates the thermocouple positions on the specimen and the percent difference of observed and predicted equilibrium temperature averaged over all the 10-amp tests and normalized against the ratio of experimental to predicted equilibrium surface temperature for position No. 5. The standard deviation in these results was less than 2%. Note, again, the significant increase in the No. 2 and No. 6 positions and the slight decrease in the No. 1, No. 3, and No. 8 positions. This expected result is explained by the 1-D assumption and the analysis of effective properties in which individual plies are not modeled in

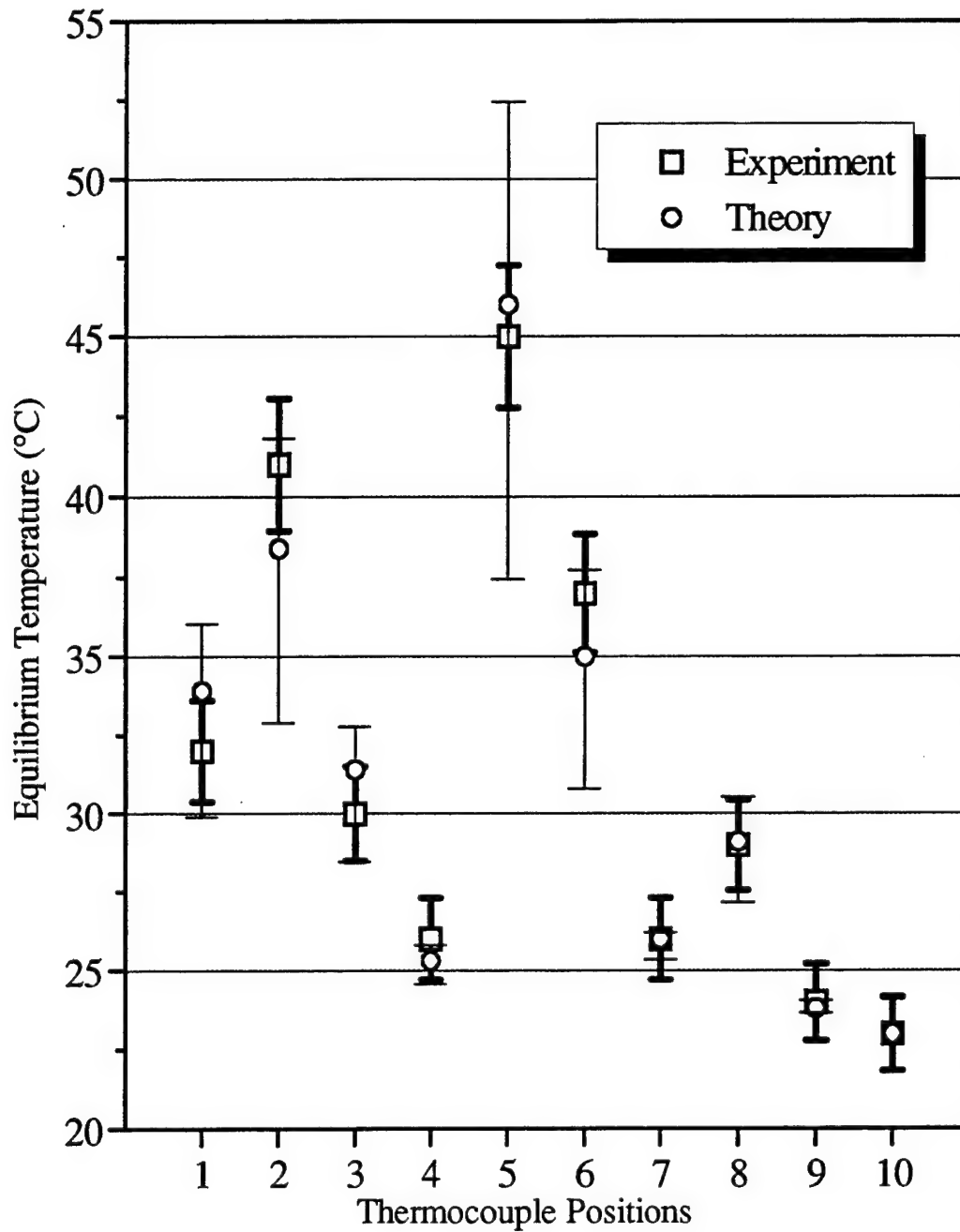


Figure 11. Experimental and Predicted Equilibrium Surface Temperature Data for Specimen (0_11_6) Including Appropriate Error for Each.

the heat-transfer analysis used in this study. Position No. 5 represents the point of highest heating in the specimen quadrant shown in Figure 12. The 1-D assumption may break down in light of the severe thermal gradients around thermocouple position No. 5. An analysis of the 3-D

1 -9.4% -	2 19.7% ++	3 -8.1% -	4 11.2%
++	5 0%	6 19.9% ++	7 15.5%
-	++	8 -3.3% -	9 N/A
			10 N/A

Figure 12. Diagram Showing Average Variation of Experimental Equilibrium Results From Predicted Equilibrium Results for All 10 Thermocouples.

heat-source distribution, provided by the in-plane planar grid and the through-thickness capacitive fiber layer models, which would provide a layer-by-layer anisotropic heat-transfer analysis would likely resolve these discrepancies. This is a topic of future work.

The positions of Nos. 2 and 6 in Figure 12 lie along fiber paths in the 0° and 90° plies; therefore, they are expected to heat somewhat faster than predicted due to the higher actual thermal conductivity in these directions vs. the effective properties used in our analysis. Likewise, the Nos. 1, 3, and 8 positions are expected to heat slower than predicted. The higher values in the Nos. 4 and 7 positions are not meaningful since the actual temperatures measured in these locations was very low. Position Nos. 9 and 10 were also low heating. Their percent-difference results are not included due to the insignificant temperature values recorded at these locations.

Again, tabular equilibrium results for all the 10-amp applied coil-current tests are available [2]. These tables, however, fail to indicate the transient behavior of the surface temperature, which would provide comparative information on heating rates. One way of providing this information is to represent transient behavior as a linear increase in temperature with time to an equilibrium temperature, T_{eq} , at time t_{eq} . The time to equilibrium is calculated from the transient results as the time to reach a temperature within 3% of the equilibrium temperature (taken at $t = 180$ s) as illustrated in Figure 13.

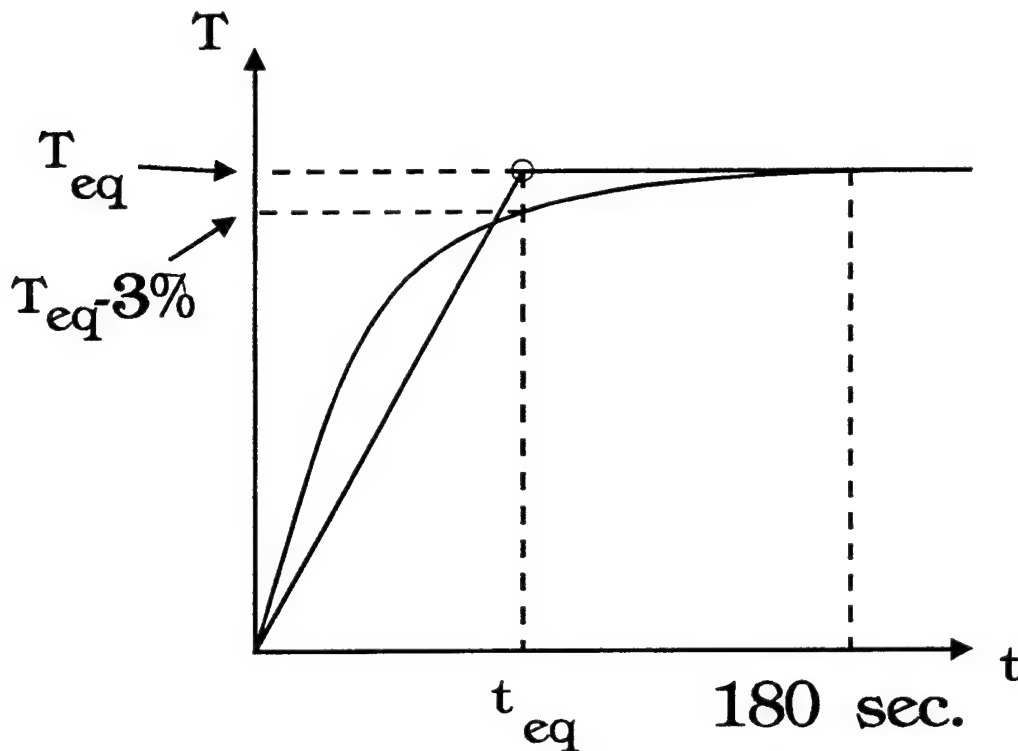


Figure 13. Schematic Definition of Equilibrium Temperature and Equilibrium Time. The Equilibrium Temperature Is Defined as the Temperature Measured at $T = 180$ s. The Equilibrium Time Is Defined as the Time at Which the Temperature Has Reached 3% of the Equilibrium Temperature. The “Time-Temperature Equilibrium Point” Is Marked With the Small Circle.

Although the various thermocouples (i.e., surface positions) reached equilibrium at different times, the average time to equilibrium is valuable for comparison between specimens. Figure 14 shows these calculated points in the thermal history data for the assumed linear heating profiles.

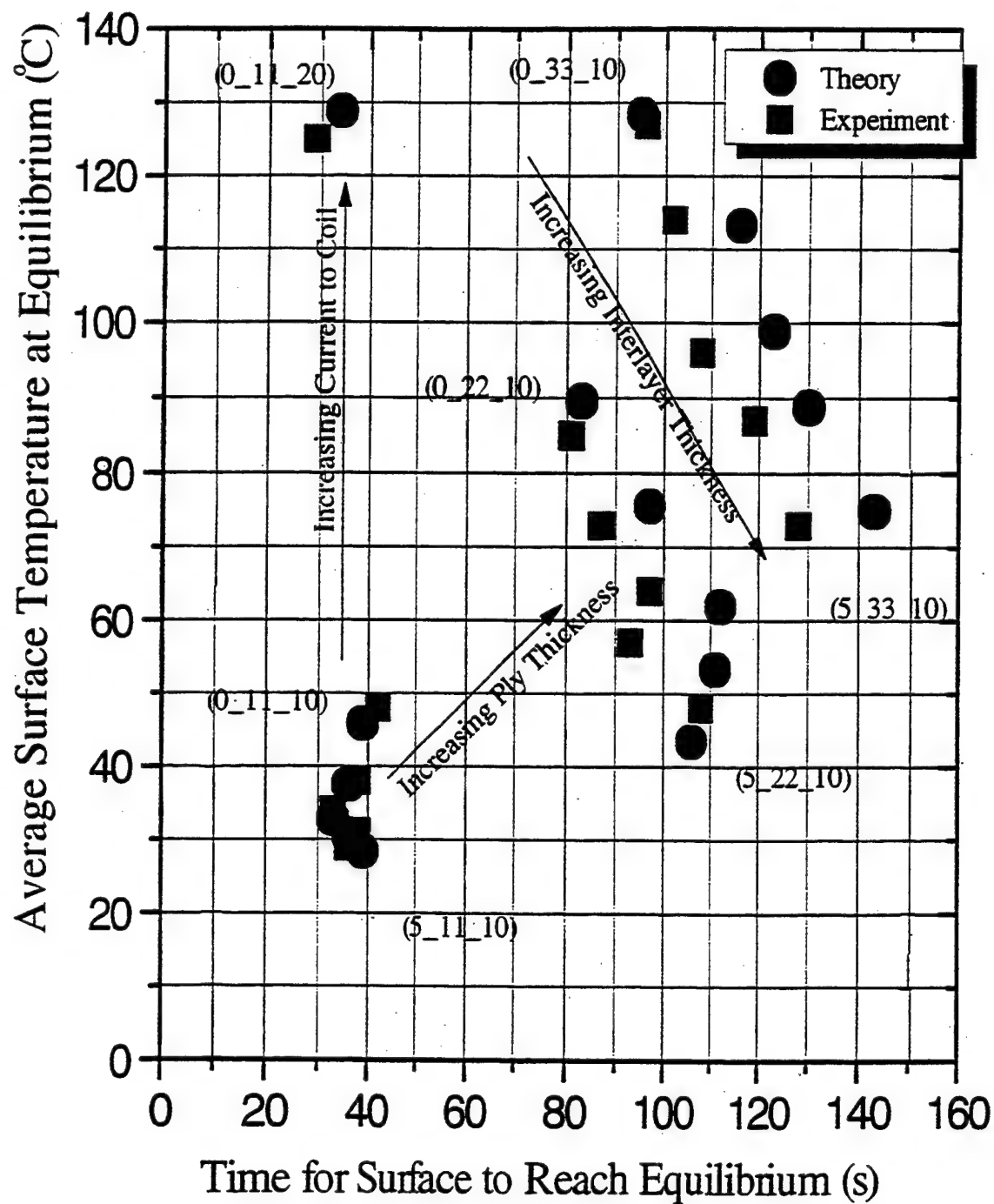


Figure 14. Summary of Time-Temperature Equilibrium Points.

Figure 14a shows that, as expected, T_{eq} and t_{eq} both increase with increasingly ply thickness; T_{eq} increases due to the higher heating predicted by our theory, and t_{eq} increases due to the increased amount of material being heated. Figure 14b shows that increasing the interlayer thickness significantly decreases T_{eq} as predicted and slightly increases t_{eq} due to less significant increases in added material; however, the material that is added has a low thermal conductivity and is in the center of the specimen. Figure 14c shows that an increase in the current to the coil increases T_{eq} dramatically, yet the time to reach equilibrium does not change.

6.2 Effect of Varying Interface Thickness. The predicted effect of varying the interface thickness on the parameter γ (given in Figure 7) indicated a rapid decrease in the heating parameter γ with increasing interface resin thickness h_o . As noted previously, the point corresponding to the location of thermocouple No. 5 in Figure 4 represents the highest predicted and recorded heating in the plane. Figure 15 shows experimental data for the equilibrium (steady state) surface temperature at this point for the [0/90], [0₂/90₂] and [0₃/90₃] specimens at 10-amp current. The error bars on the experimental results are indicative of the ± 1 °C reading of the digital thermocouple reader and an additional $\pm 5\%$ error on the accuracy of the placement of the thermocouple on the specimen. This value of 5% was determined by analyzing the changes in temperature over one square centimeter centered on the point of highest heating. Figure 16 compares predicted and experimental steady-state surface temperatures at this point for the [0/90] specimen [code (x_11_10)]. Experimental results agree quite well with predictions. Equivalent comparisons were obtained for other specimen/coil configurations [2].

6.3 Effect of Varying Ply Thickness. Figure 6 shows the predicted effect of increasing the ply thickness on the capacitive-layer-model's parameter γ . Moderate increases in the heating parameter γ were predicted for substantial increases in ply thickness. Figure 17 shows the observed effect of increasing the ply thickness on the equilibrium surface temperature at thermocouple No. 5 for various interply thicknesses. Although increasing ply thickness has little effect on the parameter γ , it has a more significant effect on the temperature. This is due to the significant increase in loss tangent of PEEK at the glass transition temperature, resulting in increased heating in those specimens that approach a temperature of 140 °C, as shown in Figure 6.

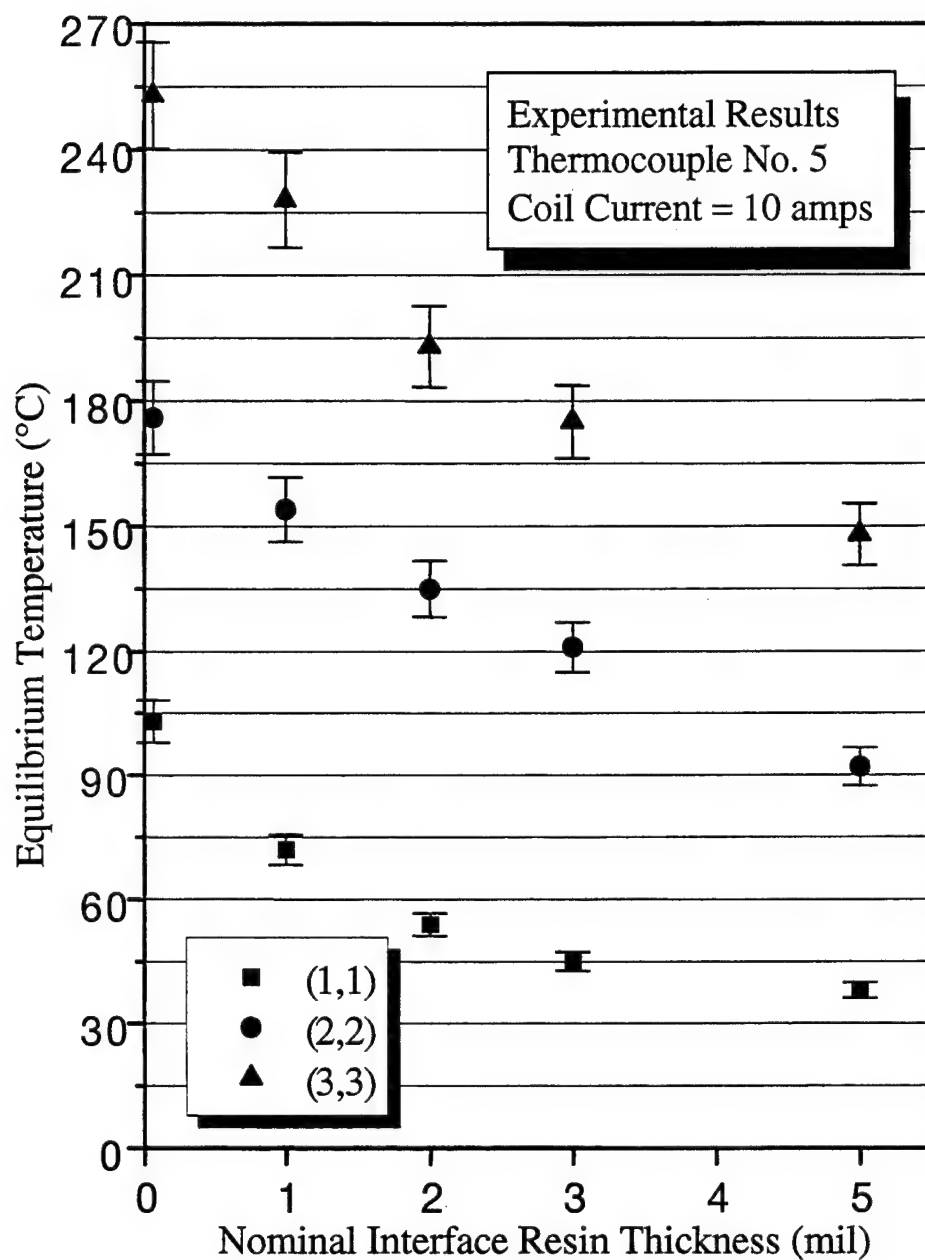


Figure 15. Experimental Results Showing Effect of Varying the Thickness of the Interfacial Resin Layer.

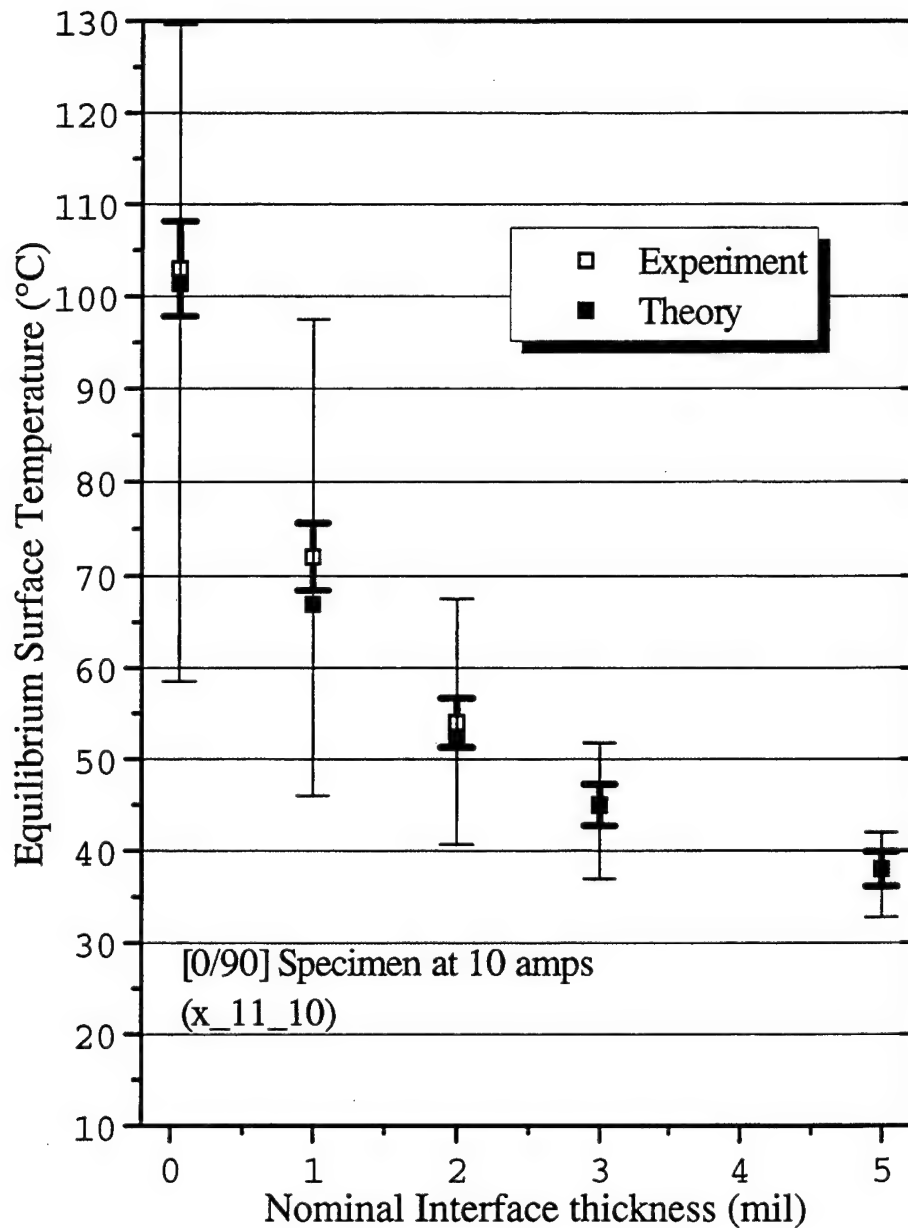


Figure 16. Comparison of Predicted and Observed Surface Temperatures Showing Effect of Increasing Interface Thickness, h_o , on Equilibrium Surface Temperature. The Heavy Lines Represent the Experimental Results, While the Thin Lines Represent Predicted Results With Upper and Lower Bounds.

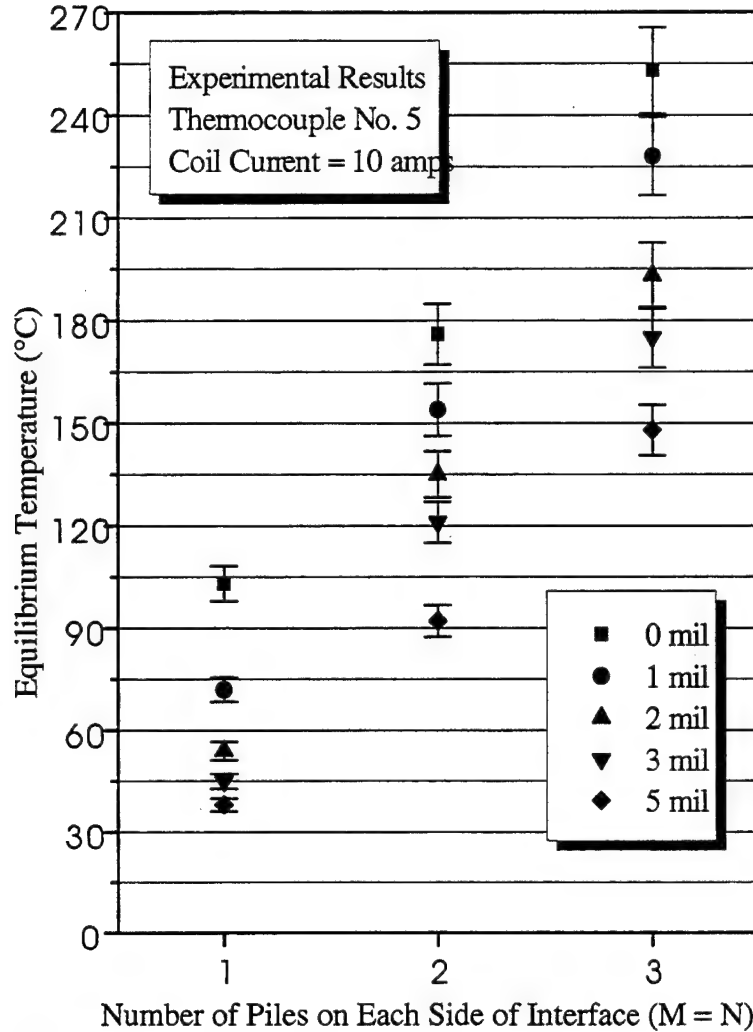


Figure 17. Experimental Observation Showing Effect of Increasing Ply Thickness on Equilibrium Surface Temperature for Various Interface Resin Thicknesses.

6.4 Effect of Varying Coil Current. Figure 18 shows the effect of varying the applied coil current (i.e., increasing the magnetic flux) on the (0₁₁/I) specimens using currents, I , of 6, 10 and 20 amp. A current-squared power relationship is expected. The curve fit shown on the graph is for the equation $T = 0.7(I)^2 + 23$ °C. With the loss tangent changing with temperature, the thermal data is expected to show a faster rise in temperature than for a constant loss tangent value. Therefore, the current-squared relationship includes both the resistive nature of heating and the variation of loss tangent with temperature, which is offset by the temperature-dependent convection and radiation losses.

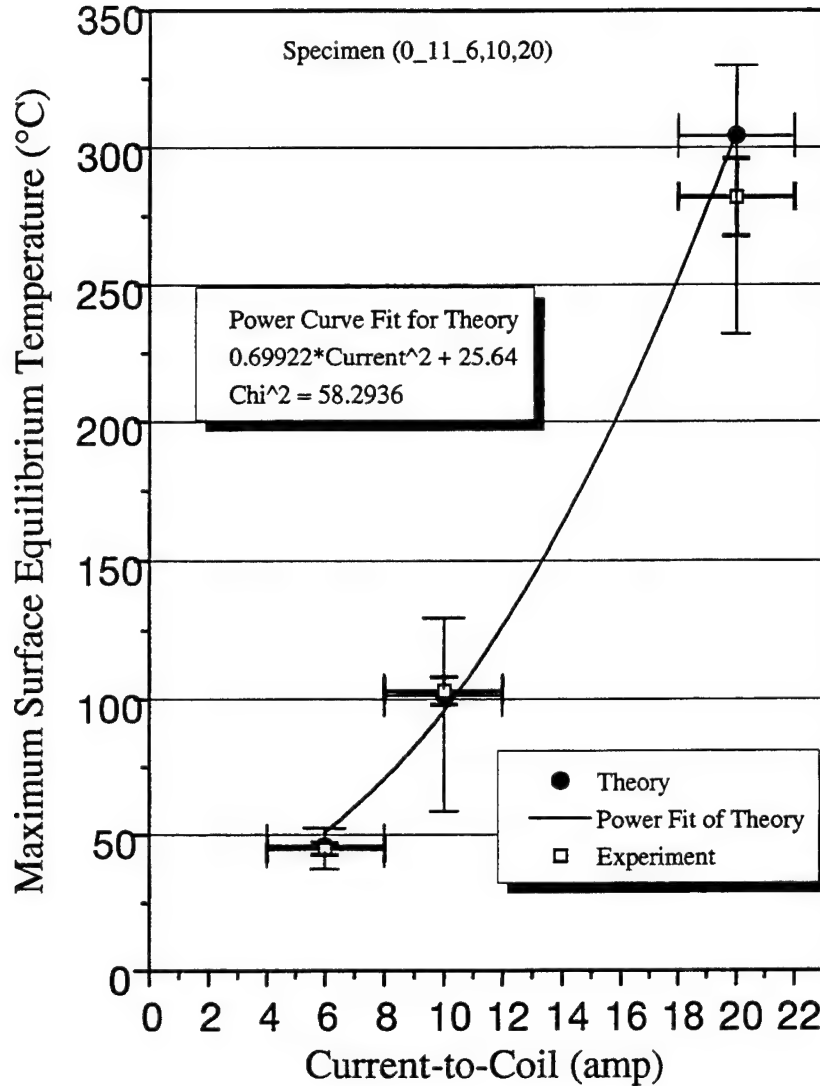


Figure 18. Comparison of Predicted and Observed Surface Temperatures Showing Effect of Applied Coil Current on Heating.

7. Summary

Local, in-plane, and through-thickness submodels were combined to provide input for a finite element heat-transfer analysis to predict transient thermal profile in the plane of thin laminates. Assumptions concerning through-thickness thermal gradients and linearity of potential field gradients in the plane were imposed to obtain a solution. The validity of the assumptions that

encompass the thermal submodel are supported by the agreement with the model's output with experimental data. The convection heat-transfer coefficient was experimentally determined.

An experimental test matrix and apparatus were employed to verify the proposed theory of dielectric heating as the fundamental mechanism of thermal generation in continuous carbon-fiber thermoplastic-matrix cross-ply laminated composites subjected to a transverse magnetic field. It has been shown that, as the ply-ply interface resin-rich region thickness h_o increases, the heating in the laminate decreases significantly. This indicates that Joule heating due to fiber-fiber contact is not likely. Furthermore, increasing the number of plies on either side of the interface increases the heating indicating that thermal generation in the laminate is a function of ply thickness and most likely occurs throughout the thickness of the laminate.

The accuracy of the surface temperature measurements to those predicted under a variety of physical parameters gives credence to the validity of the original proposal stated in Fink, McCullough, and Gillespie [1]. Claims of Joule losses in the fibers [10–13], fiber contact resistance losses, and local-only heating at the ply-ply interface are not supported by the current experimental investigation. Joule losses in the fibers would result in constant heating on the perimeter of the Helmholtz-type coil—this was not the case; heating was shown to occur at precise points and with specific intensities as predicted by the global model. Fiber contact resistance losses, while potentially exhibiting similar qualitative heating patterns, would induce significant current in the fibers themselves, resulting in measurable Joule heating in the fibers. This was not witnessed in this study. Although not directly shown, the existence of the gradient of heating through the thickness of the laminate, as predicted by the capacitive fiber layer submodel, is indirectly supported by the model's ability to predict the total thermal generation. However, the quantitative summation of through-thickness heat generation was verified. If heating only occurred at the resin-rich ply-ply interface (h_o region), then the expected total heating would be significantly lower and result in significantly lower surface temperatures.

Continuing work involves extending the present theory and models to laminates containing off-axis plies and performing a 3-D heat-transfer analysis using anisotropic properties and a ply-by-ply approach. This will allow the investigation of thick laminates to further verify the through-thickness thermal generation model and provide insight into special problems associated with angle-ply laminates.

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